

TOSHIBA GTR MODULE SILICON N CHANNEL IGBT

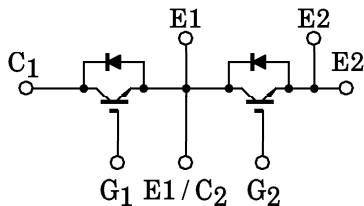
# MG90V2YS40

HIGH POWER SWITCHING APPLICATIONS

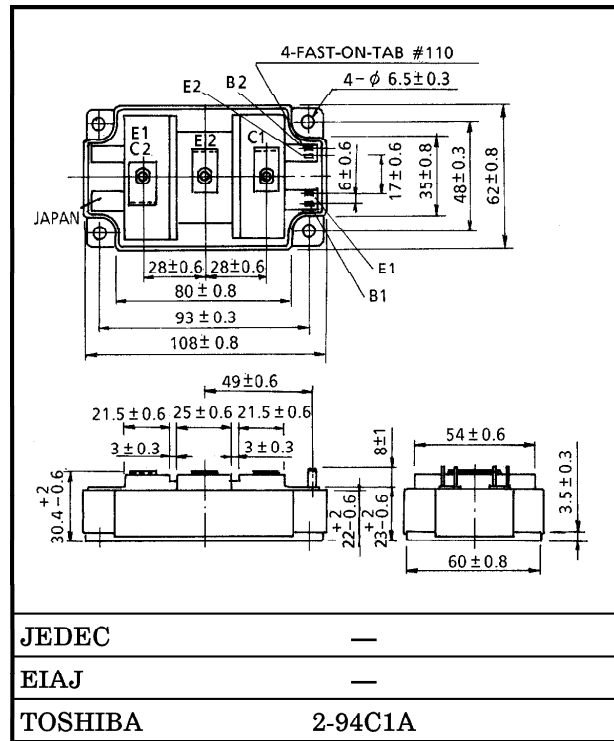
MOTOR CONTROL APPLICATIONS

- The Electrodes are Isolated from Case.
- High Input Impedance
- Includes a Complete Half Bridge in One Package.
- Enhancement-Mode
- High Speed :  $t_f = 1.5 \mu s$  (Max.) ( $I_C = 90A$ )  
 $t_{rr} = 0.3 \mu s$  (Max.) ( $I_F = 90A$ )

EQUIVALENT CIRCUIT



Unit in mm



Weight : 430g (TYP.)

MAXIMUM RATINGS (Ta = 25°C)

CHARACTERISTIC	SYMBOL	RATING	UNIT
Collector-Emitter Voltage	$V_{CES}$	1700	V
Gate-Emitter Voltage	$V_{GES}$	± 20	V
Collector Current	DC	$I_C$	90
	1ms	$I_{CP}$	180
Forward Current	DC	$I_F$	90
	1ms	$I_{FM}$	180
Collector Power Dissipation (Tc = 25°C)	$P_C$	1100	W
Junction Temperature	$T_j$	150	°C
Storage Temperature Range	$T_{stg}$	-40~125	°C
Isolation Voltage	$V_{Isol}$	4000 (AC 1 min.)	V
Screw Torque (Terminal / Mounting)	—	3 / 3	N·m

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ELECTRICAL CHARACTERISTICS (Ta = 25°C)

CHARACTERISTIC		SYMBOL	TEST CONDITION	MIN.	TYP.	MAX.	UNIT
Gate Leakage Current		$I_{GES}$	$V_{GE} = \pm 20V, V_{CE} = 0$	—	—	$\pm 100$	nA
Collector Cut-off Current		$I_{CES}$	$V_{CE} = 1700V, V_{GE} = 0$	—	—	1.0	mA
Gate-Emitter Cut-off Voltage		$V_{GE} (off)$	$I_C = 90mA, V_{CE} = 5V$	4.0	—	8.0	V
Collector-Emitter Saturation Voltage		$V_{CE} (sat)$	$I_C = 90A, V_{GE} = 15V$	—	3.2	4.5	V
Input Capacitance		$C_{ies}$	$V_{CE} = 10V, V_{GE} = 0, f = 1MHz$	—	13000	—	pF
Switching Time	Turn-on Delay Time	$t_d (on)$	Inductive Load $V_{CC} = 900V$ $I_C = 90A$ $V_{GE} = \pm 15V$ $R_G = 5.6\Omega$ (Note 1)	—	0.1	—	$\mu s$
	Rise Time	$t_r$		—	0.1	—	
	Turn-on Time	$t_{on}$		—	0.5	—	
	Turn-off Delay Time	$t_d (off)$		—	0.4	—	
	Fall Time	$t_f$		—	0.5	1.5	
	Turn-off Time	$t_{off}$		—	1.0	—	
Forward Voltage		$V_F$	$I_F = 90A, V_{GE} = 0$	—	3.2	4.5	V
Reverse Recovery Time		$t_{rr}$	$I_F = 90A, V_{GE} = -15V$ $di / dt = 500A / \mu s$ (Note 1)	—	0.2	0.4	$\mu s$
Thermal Resistance		$R_{th (j-c)}$	Transistor Stage	—	—	0.114	$^{\circ}C / W$
			Diode Stage	—	—	0.4	

Note 1 Switching Time and Reverse Recovery Time Test Circuit & Timing Chart

